

L Number	Hits	Search Text	DB	Time stamp
1	46	magnetic adj head and wafer and slider and dummy	USPAT; US-PGPUB; EP ; JP ; DERWENT; IBM_TDB	2003/06/25 10:07
2	5	("5065483" "5597340" "5722155" "5913550" "5991698").PN.	USPAT	2003/06/25 09:58
3	0	slider and wafer and dummy adj section	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 10:08
-	15	magnetic adj head and supporting near jig	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 09:43
-	1	supporting near jig and wafer and cutting and raw near bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 15:50
-	0	20010037555.URPN.	USPAT	2003/06/24 15:49
-	0	20010037555.URPN.	USPAT	2003/06/24 15:50
-	1	supporting near jig and raw near bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 15:52
-	3	supporting near jig and raw same bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 15:54
-	0	supporting near jig and dummy near section and raw same bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 15:55
-	0	supporting near jig and dummy near section and bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 15:55
-	0	supporting near jig and dummy near section	USPAT; US-PGPUB; EPO; JP ; DERWENT; IBM_TDB	2003/06/24 15:56

-	9	jig and dummy near secti n	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 15:56
-	1	"6077724".PN.	USPAT	2003/06/24 15:58
-	200	supporting near jig and bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:07
-	8	("4769342" "5063173" "5144634" "5171717" "5228047" "5604764" "5665637" "5773318").PN.	USPAT	2003/06/24 16:00
-	3	("4731792" "4879725" "4901328").PN.	USPAT	2003/06/24 16:04
-	3	supporting near jig and dummy and bars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:21
-	3	6332264.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:57
-	1	2000-059307.NRAN.	DERWENT	2003/06/24 16:43
-	0	SHIZAKI near ITOH.inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:45
-	225	Itoh near Hiroyuki .in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:45
-	6	Itoh near Hiroyuki .in. and slider and dummy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:46
-	8	("4536992" "5020213" "5095613" "5329689" "5406694" "5463805" "5603156" "5718035").PN.	USPAT	2003/06/24 16:48
-	6	("4226018" "4333229" "4489484" "5095613" "5321882" "5406694").PN.	USPAT	2003/06/24 16:49
-	8	("4536992" "5020213" "5095613" "5329689" "5406694" "5463805" "5603156" "5718035").PN.	USPAT	2003/06/24 16:51

-	3	(("4536992" "5020213" "5095613" "5329689" "5406694" "5463805" "5603156" "5718035").PN.) and (29/603; 29/603.16 ; 29/603.2 ; 29/603.15 ; 29/603.14 ; 360/113 ; 360/104 ; 360/105 ; 360/122 ; 360/125).cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 16:58
-	148	lapping and slider and jig dummy adj section and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 17:14
-	0	lapping and slider and dummy near section and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 17:15
-	12	lapping and slider and jig and dummy and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 17:16
-	30670	photosensitive near drum	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 07:41
-	3	photosensitive near drum and 29/\$.cccls. and 430/\$.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 07:48
-	300	tubular and welding and laser and 29/\$.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 07:51
-	22	tubular and welding and laser and 29/\$.cccls. and 72/\$.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 08:12
-	7	solder adj bump near forming and 29/740.cccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 08:23

-	24	("4333966" "4401767" "4436785" "4459166" "4463030" "4652465" "4670188" "4749120" "4855102" "4859241" "5194128" "5196371" "5286927" "5477419" "5714252" "5832595" "5860212" "5882722" "5918364" "5976393" "5981305" "6010831" "6068939" "6189208" "2001/0006455")).PN.	USPAT	2003/06/25 08:17
-	439	fibre near optic and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 08:24